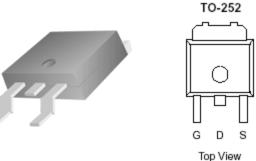
P-Channel 40-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low $r_{DS(on)}$ and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

| printers, PCMCL | A cards, centulai | and cordie | SS | | $\overline{}$ | |
|-----------------|-------------------|------------|----|--|---------------|--|
| telephones. | | | | | | |
| | | | | | | |
| T | .1 1.1 | cc · | 1 | | | |

- Low r_{DS(on)} provides higher efficiency and extends battery life
- Low thermal impedance copper leadframe DPAK saves board space
- Fast switching speed
- High performance trench technology

| PRODUCT SUMMARY | | | | |
|---------------------|------------------------|------------|--|--|
| V _{DS} (V) | $r_{DS(on)} m(\Omega)$ | $I_{D}(A)$ | | |
| -40 | $69 @ V_{GS} = -10V$ | 22 | | |
| -40 | $106 @ V_{GS} = -4.5V$ | 18 | | |



| ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C U | INLESS OI | HERWS | SE NOTED |) |
|---|----------------------|------------------|------------|-------|
| Parameter | | Symbol | Maximum | Units |
| Drain-Source Voltage | V_{DS} | -40 | V | |
| Cate-Source Voltage | V_{GS} | ±20 | · | |
| Continuous Drain Current ^a | I_D | 22 | | |
| Pulsed Drain Current ^b | I_{DM} | ±72 | Α | |
| Continuous Source Current (Diode Conduction) ^a | I_S | -30 | Α | |
| Power Dissipation ^a | T _A =25°C | P_{D} | 50 | W |
| Operating Junction and Storage Temperature Range | | | -55 to 175 | °C |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|----------------|---------|-------|--|--|
| Parameter | Symbol | Maximum | Units | | |
| Maximum Junction-to-Ambient ^a | $R_{	heta JA}$ | 50 | °C/W | | |
| Maximum Junction-to-Case | $R_{	heta JC}$ | 3.0 | °C/W | | |

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

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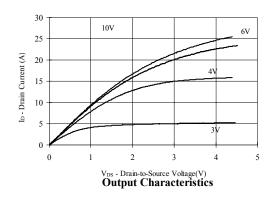
| SPECIFICATIONS (T _A = 25°C UNLESS OTHERWISE NOTED) | | | | | | | |
|---|-----------------------------|--|--------|------|------|------|--|
| Parame te r | Symbol | Test Conditions | Limits | | | Unit | |
| rarameter | Symbol | Test Conditions | Min | Тур | Max | Umi | |
| Static | | | | | • | | |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = -250 \text{ uA}$ | -1 | | | | |
| Gate-Body Leakage | Igss | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$ | | | ±100 | nA | |
| Zero Gate Voltage Drain Current | IDSS | $V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$ | | | -1 | uA | |
| Zero Gate Voltage Diam Current | IDSS | $V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$ | | | -5 | | |
| On-State Drain Current ^A | I _{D(on)} | $V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$ | -41 | | | Α | |
| D i G O D i A | ****** | $V_{GS} = -10 \text{ V}, I_D = -22 \text{ A}$ | | | 69 | mΩ | |
| Drain-Source On-Resistance ^A | fDS(on) | $V_{GS} = -4.5 \text{ V}, I_D = -18 \text{ A}$ | | | 106 | IILZ | |
| Forward Tranconductance ^A | gs | $V_{DS} = -15 \text{ V}, I_D = -22 \text{ A}$ | | 31 | | S | |
| Diode Forward Voltage | V_{SD} | $I_S = -41 \text{ A}, V_{GS} = 0 \text{ V}$ | | -0.7 | | V | |
| Dynamic ^b | • | | • | | • | • | |
| Total Gate Charge | Qg | $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V},$ | | 10 | | | |
| Gate-Source Charge | Q_{gs} | $I_D = -22 \text{ A}$ | | 2.2 | | nC | |
| Gate-Drain Charge | Qgd | ID22 A | | 2.5 | | | |
| Switching | · | | | | | | |
| Turn-On Delay Time | t _{d(on)} | | | 10 | | | |
| Rise Time | $t_{\rm r}$ | $V_{DD} = -15 \text{ V}, R_L = 15 \Omega, ID = -24 \text{ A},$ | | 2.8 | | nS | |
| Turn-Off Delay Time | t _{d(off)} | $VGEN = -10 \text{ V}, RG = 6\Omega$ | | 53.6 | | | |
| Fall-Time | $\mathfrak{t}_{\mathrm{f}}$ | | | 46 | | | |

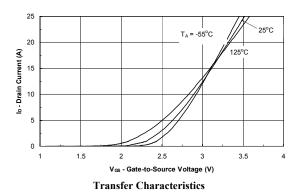
Notes

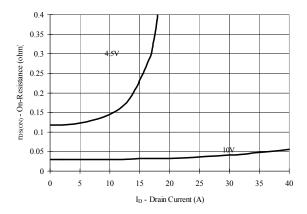
- a. Pulse test: $PW \le 300us duty cycle \le 2\%$.
- b. Guaranteed by design, not subject to production testing.

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Typical Electrical Characteristics







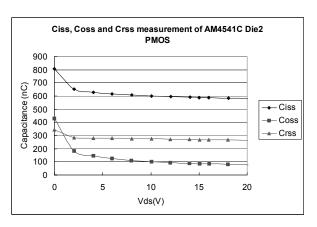
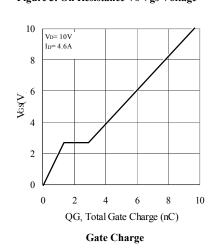
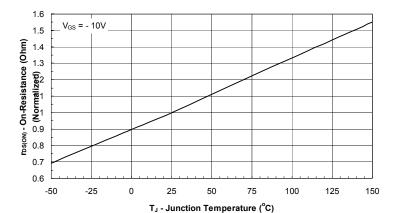


Figure 3. On Resistance Vs Vgs Voltage

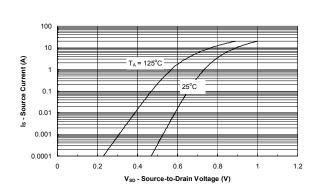


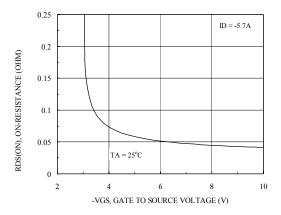


Capacitance

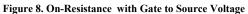
On-Resistance vs. Junction Temperature

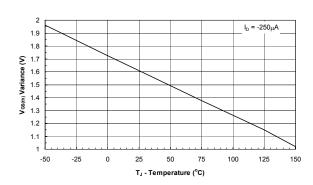
Typical Electrical Characteristics

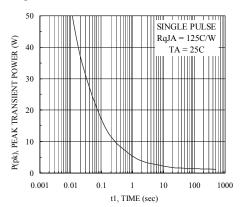




Source-Drain Diode Forward Voltage







Threshold Voltage

Figure 10. Single Pulse Maximum Power Dissipation

Normalized Thermal Transient Junction to Ambient

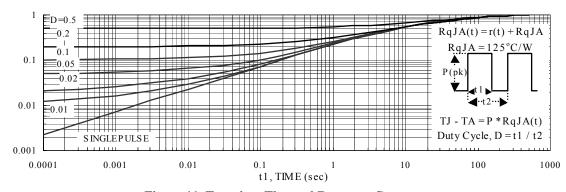
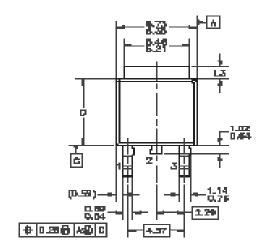
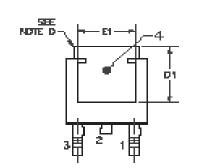
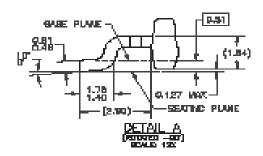


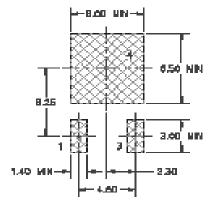
Figure 11. Transient Thermal Response Curve

Package Information

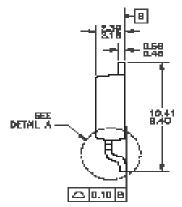








LAND PATTERN RECOMMENDATION



NOTES: UNLESS OTHERWISE SPECIFIED

- ALL DIVERSIONS ARE IN NULLWETERS.
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